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MICROCHIP

dsPIC33FJ12MC201/202
Data Sheet

High-Performance,
16-bit Digital Signal Controllers

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dsPIC33FJ12MC201/202

High-Performance, 16-bit Digital Signal Controllers

Operating Range:

- Up to 40 MIPS operation (at 3.0-3.6V):
 - Industrial temperature range (-40°C to +85°C)
 - Extended temperature range (-40°C to +125°C)

High-Performance DSC CPU:

- Modified Harvard architecture
- C compiler optimized instruction set
- 16-bit-wide data path
- 24-bit-wide instructions
- Linear program memory addressing up to 4M instruction words
- Linear data memory addressing up to 64 Kbytes
- 83 base instructions: mostly one word/one cycle
- Two 40-bit accumulators with rounding and saturation options
- Flexible and powerful addressing modes:
 - Indirect
 - Modulo
 - Bit-Reversed
- Software stack
- 16 x 16 fractional/integer multiply operations
- 32/16 and 16/16 divide operations
- Single-cycle multiply and accumulate:
 - Accumulator write back for DSP operations
 - Dual data fetch
- Up to ± 16 -bit shifts for up to 40-bit data

Timers/Capture/Compare/PWM:

- Timer/Counters, up to three 16-bit timers
 - Can pair up to make one 32-bit timer
 - One timer runs as Real-Time Clock with external 32.768 kHz oscillator
 - Programmable prescaler
- Input Capture (up to four channels):
 - Capture on up, down, or both edges
 - 16-bit capture input functions
 - 4-deep FIFO on each capture
- Output Compare (up to two channels):
 - Single or Dual 16-bit Compare mode
 - 16-bit Glitchless PWM mode

Interrupt Controller:

- 5-cycle latency
- Up to 26 available interrupt sources
- Up to three external interrupts
- Seven programmable priority levels
- Four processor exceptions

Digital I/O:

- Peripheral pin Select functionality
- Up to 21 programmable digital I/O pins
- Wake-up/Interrupt-on-Change for up to 21 pins
- Output pins can drive from 3.0V to 3.6V
- Up to 5V output with open drain configurations on 5V tolerant pins
- 4 mA sink on all I/O pins

On-Chip Flash and SRAM:

- Flash program memory (12 Kbytes)
- Data SRAM (1024 bytes)
- Boot and General Security for program Flash

System Management:

- Flexible clock options:
 - External, crystal, resonator, internal RC
 - Fully integrated Phase-Locked Loop (PLL)
 - Extremely low-jitter PLL
- Power-up Timer
- Oscillator Start-up Timer/Stabilizer
- Watchdog Timer with its own RC oscillator
- Fail-Safe Clock Monitor
- Reset by multiple sources

Power Management:

- On-chip 2.5V voltage regulator
- Switch between clock sources in real time
- Idle, Sleep, and Doze modes with fast wake-up

dsPIC33FJ12MC201/202

Motor Control Peripherals:

- 6-channel 16-bit Motor Control PWM:
 - Three duty cycle generators
 - Independent or Complementary mode
 - Programmable dead time and output polarity
 - Edge-aligned or center-aligned
 - Manual output override control
 - One Fault input
 - Trigger for ADC conversions
 - PWM frequency for 16-bit resolution (@ 40 MIPS) = 1220 Hz for Edge-Aligned mode, 610 Hz for Center-Aligned mode
 - PWM frequency for 11-bit resolution (@ 40 MIPS) = 39.1 kHz for Edge-Aligned mode, 19.55 kHz for Center-Aligned mode
- 2-channel 16-bit Motor Control PWM:
 - One duty cycle generator
 - Independent or Complementary mode
 - Programmable dead time and output polarity
 - Edge-aligned or center-aligned
 - Manual output override control
 - One Fault input
 - Trigger for ADC conversions
 - PWM frequency for 16-bit resolution (@ 40 MIPS) = 1220 Hz for Edge-Aligned mode, 610 Hz for Center-Aligned mode
 - PWM frequency for 11-bit resolution (@ 40 MIPS) = 39.1 kHz for Edge-Aligned mode, 19.55 kHz for Center-Aligned mode
- Quadrature Encoder Interface module:
 - Phase A, Phase B, and index pulse input
 - 16-bit up/down position counter
 - Count direction status
 - Position Measurement (x2 and x4) mode
 - Programmable digital noise filters on inputs
 - Alternate 16-bit Timer/Counter mode
 - Interrupt on position counter rollover/underflow

Analog-to-Digital Converters (ADCs):

- 10-bit, 1.1 Msps or 12-bit, 500 Ksps conversion:
 - Two and four simultaneous samples (10-bit ADC)
 - Up to six input channels with auto-scanning
 - Conversion start can be manual or synchronized with one of four trigger sources
 - Conversion possible in Sleep mode
 - ± 2 LSb max integral nonlinearity
 - ± 1 LSb max differential nonlinearity

CMOS Flash Technology:

- Low-power, high-speed Flash technology
- Fully static design
- 3.3V ($\pm 10\%$) operating voltage
- Industrial and Extended temperature
- Low power consumption

Communication Modules:

- 4-wire SPI:
 - Framing supports I/O interface to simple codecs
 - Supports 8-bit and 16-bit data
 - Supports all serial clock formats and sampling modes
- I²C™:
 - Full Multi-Master Slave mode support
 - 7-bit and 10-bit addressing
 - Bus collision detection and arbitration
 - Integrated signal conditioning
 - Slave address masking
- UART:
 - Interrupt on address bit detect
 - Interrupt on UART error
 - Wake-up on Start bit from Sleep mode
 - 4-character TX and RX FIFO buffers
 - LIN bus support
 - IrDA® encoding and decoding in hardware
 - High-Speed Baud mode
 - Hardware Flow Control with CTS and RTS

Packaging:

- 20-pin PDIP/SOIC/SSOP
- 28-pin SPDIP/SOIC/SSOP/QFN

| |
|--|
| Note: See Table 1 for the exact peripheral features per device. |
|--|

dsPIC33FJ12MC201/202

dsPIC33FJ12MC201/202 PRODUCT FAMILIES

The device names, pin counts, memory sizes, and peripheral availability of each device are listed in [Table 1](#). The following pages show their pinout diagrams.

TABLE 1: dsPIC33FJ12MC201/202 CONTROLLER FAMILIES

| Device | Pins | Program Flash Memory (Kbyte) | RAM (Kbyte) | Remappable Peripherals | | | | | | | | 10-Bit/12-Bit ADC | I ² C™ | I/O Pins | Packages | |
|------------------|------|------------------------------|-------------|------------------------|------------------|---------------|-----------------------------|--|------------------------------|------|------------------------------------|-------------------|-------------------|----------|----------|------------------------------|
| | | | | Remappable Pins | 16-bit Timer | Input Capture | Output Compare Standard PWM | Motor Control PWM | Quadrature Encoder Interface | UART | External Interrupts ⁽³⁾ | | | | | SPI |
| dsPIC33FJ12MC201 | 20 | 12 | 1 | 10 | 3 ⁽¹⁾ | 4 | 2 | 4ch ⁽²⁾ 2ch ⁽²⁾ | 1 | 1 | 3 | 1 | 1ADC, 4 ch | 1 | 15 | PDIP SOIC SSOP |
| dsPIC33FJ12MC202 | 28 | 12 | 1 | 16 | 3 ⁽¹⁾ | 4 | 2 | 6ch ⁽²⁾ 2ch ⁽²⁾ | 1 | 1 | 3 | 1 | 1ADC, 6 ch | 1 | 21 | SPDIP SOIC SSOP QFN |

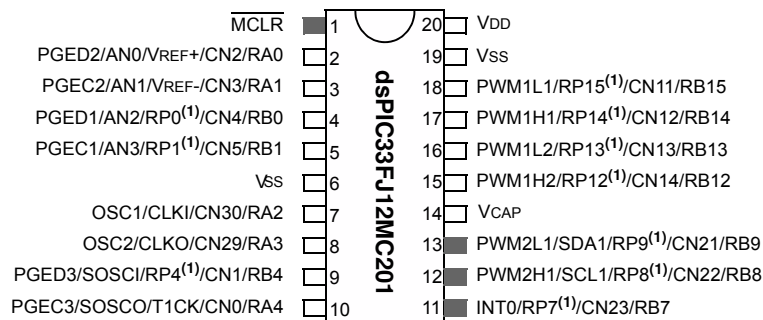
- Note 1:** Only two out of three timers are remappable.
Note 2: Only PWM fault inputs are remappable.
Note 3: Only two out of three interrupts are remappable.

dsPIC33FJ12MC201/202

Pin Diagrams

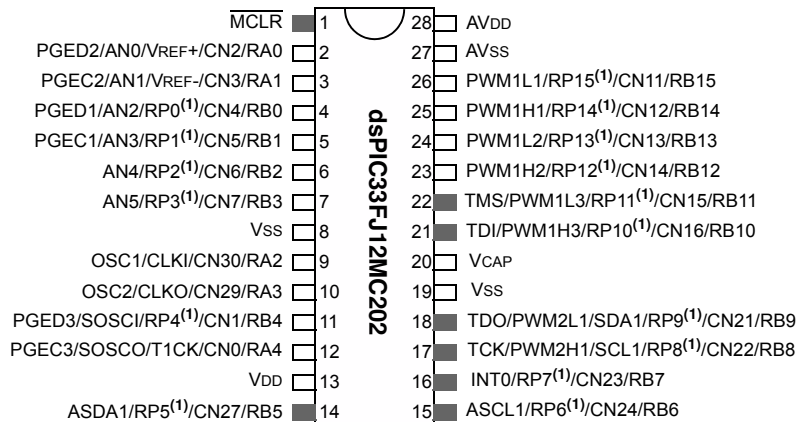
20-PIN PDIP, SOIC, SSOP

■ = Pins are up to 5V tolerant



28-PIN SPDIP, SOIC, SSOP

■ = Pins are up to 5V tolerant

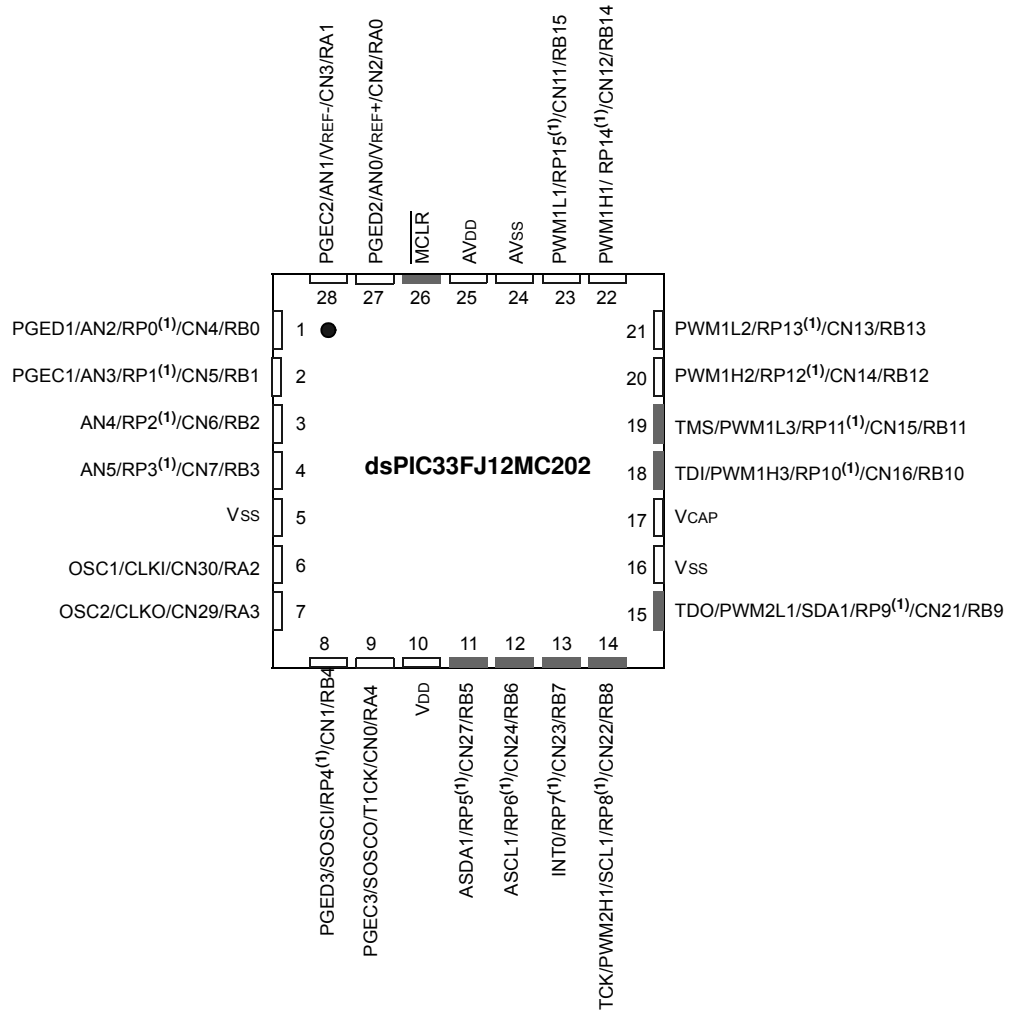


Note 1: The RPn pins can be used by any remappable peripheral. See [Table 1](#) for the list of available peripherals.

Pin Diagrams (Continued)

28-Pin QFN⁽²⁾

■ = Pins are up to 5V tolerant



Note 1: The RPN pins can be used by any remappable peripheral. See [Table 1](#) for the list of available peripherals.

2: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.

dsPIC33FJ12MC201/202

Table of Contents

| | |
|---|-----|
| dsPIC33FJ12MC201/202 Product Families | 5 |
| 1.0 Device Overview | 9 |
| 2.0 Guidelines for Getting Started with 16-bit Digital Signal Controllers | 15 |
| 3.0 CPU | 19 |
| 4.0 Memory Organization | 31 |
| 5.0 Flash Program Memory | 57 |
| 6.0 Resets | 63 |
| 7.0 Interrupt Controller | 71 |
| 8.0 Oscillator Configuration | 103 |
| 9.0 Power-Saving Features | 113 |
| 10.0 I/O Ports | 119 |
| 11.0 Timer1 | 141 |
| 12.0 Timer2/3 Feature | 143 |
| 13.0 Input Capture | 149 |
| 14.0 Output Compare | 151 |
| 15.0 Motor Control PWM Module | 155 |
| 16.0 Quadrature Encoder Interface (QEI) Module | 169 |
| 17.0 Serial Peripheral Interface (SPI) | 173 |
| 18.0 Inter-Integrated Circuit™ (I ² C™) | 179 |
| 19.0 Universal Asynchronous Receiver Transmitter (UART) | 187 |
| 20.0 10-bit/12-bit Analog-to-Digital Converter (ADC) | 193 |
| 21.0 Special Features | 205 |
| 22.0 Instruction Set Summary | 211 |
| 23.0 Development Support | 219 |
| 24.0 Electrical Characteristics | 223 |
| 25.0 Packaging Information | 271 |
| Appendix A: Revision History | 287 |
| Index | 297 |
| The Microchip Web Site | 301 |
| Customer Change Notification Service | 301 |
| Customer Support | 301 |
| Reader Response | 302 |
| Product Identification System | 303 |

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To determine if an errata sheet exists for a particular device, please check with one of the following:

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1.0 DEVICE OVERVIEW

Note 1: This data sheet summarizes the features of the dsPIC33FJ12MC201/202 devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the “*dsPIC33F/PIC24H Family Reference Manual*”. Please see the Microchip web site (www.microchip.com) for the latest dsPIC33F/PIC24H Family Reference Manual sections.

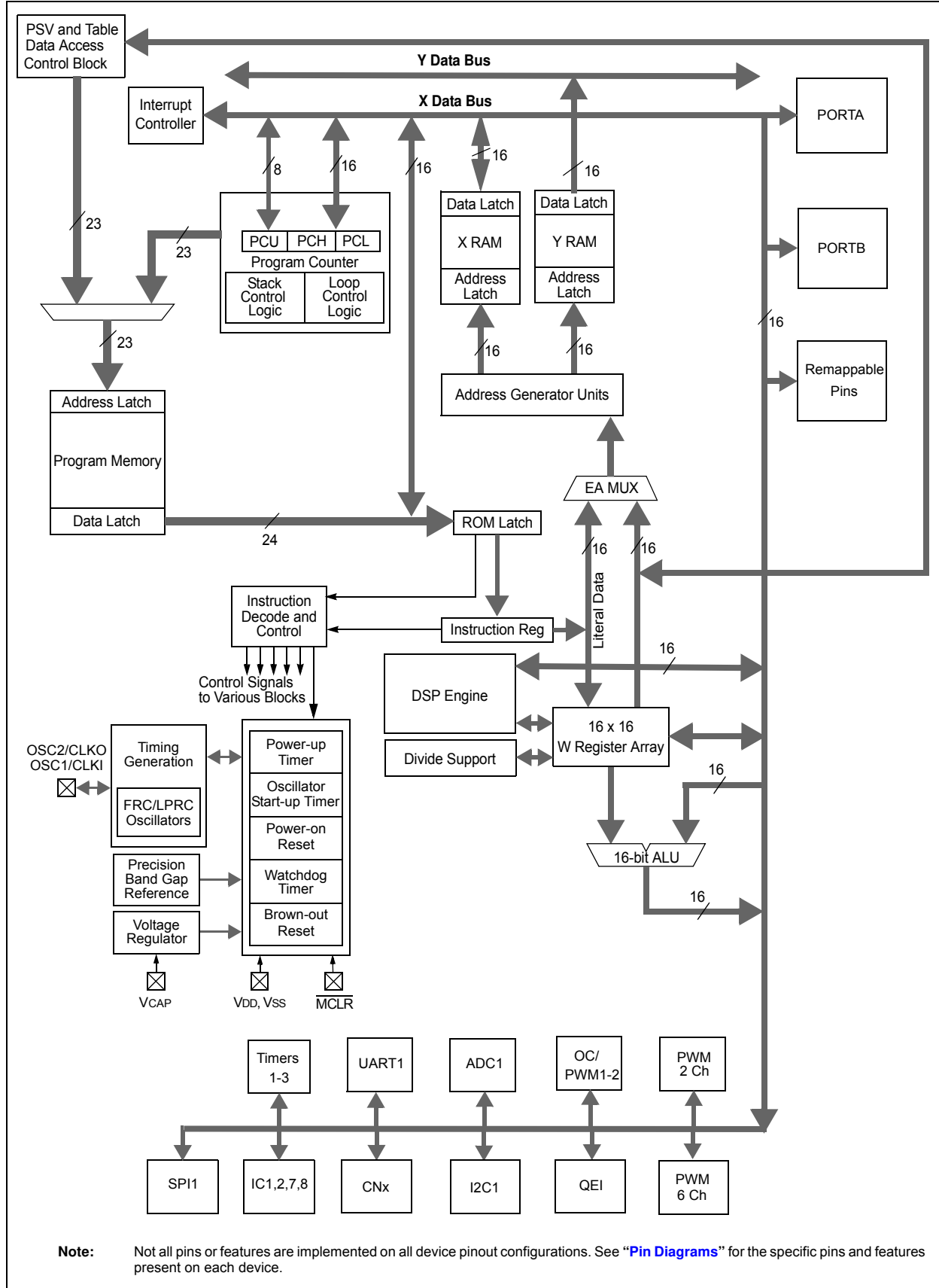
2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

This document contains device specific information for the dsPIC33FJ12MC201/202 Digital Signal Controller (DSC) Devices. The dsPIC33F devices contain extensive Digital Signal Processor (DSP) functionality with a high-performance, 16-bit microcontroller (MCU) architecture.

[Figure 1-1](#) shows a general block diagram of the core and peripheral modules in the dsPIC33FJ12MC201/202 family of devices. [Table 1-1](#) lists the functions of the various pins shown in the pinout diagrams.

dsPIC33FJ12MC201/202

FIGURE 1-1: dsPIC33FJ12MC201/202 BLOCK DIAGRAM



Note: Not all pins or features are implemented on all device pinout configurations. See "Pin Diagrams" for the specific pins and features present on each device.

dsPIC33FJ12MC201/202

TABLE 1-1: PINOUT I/O DESCRIPTIONS

| Pin Name | Pin Type | Buffer Type | PPS | Description |
|--|----------|-------------|----------------------------|--|
| AN0-AN5 | I | Analog | No | Analog input channels. |
| CLKI | I | ST/CMOS | No | External clock source input. Always associated with OSC1 pin function. |
| CLKO | O | — | No | Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. Optionally functions as CLKO in RC and EC modes. Always associated with OSC2 pin function. |
| OSC1 | I | ST/CMOS | No | Oscillator crystal input. ST buffer when configured in RC mode; CMOS otherwise. |
| OSC2 | I/O | — | No | Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. Optionally functions as CLKO in RC and EC modes. |
| SOSCI | I | ST/CMOS | No | 32.768 kHz low-power oscillator crystal input; CMOS otherwise. |
| SOSCO | O | — | No | 32.768 kHz low-power oscillator crystal output. |
| CN0-CN7 CN11-CN16 CN21-CN24 CN27 CN29-CN30 | I | ST | No No No No No | Change notification inputs. Can be software programmed for internal weak pull-ups on all inputs. |
| IC1-IC2 | I | ST | Yes | Capture inputs 1/2. |
| IC7-IC8 | I | ST | Yes | Capture inputs 7/8. |
| OCFA | I | ST | Yes | Compare Fault A input (for Compare Channels 1 and 2). |
| OC1-OC2 | O | — | Yes | Compare outputs 1 through 2. |
| INT0 | I | ST | No | External interrupt 0. |
| INT1 | I | ST | Yes | External interrupt 1. |
| INT2 | I | ST | Yes | External interrupt 2. |
| RA0-RA4 | I/O | ST | No | PORTA is a bidirectional I/O port. |
| RB0-RB15 | I/O | ST | No | PORTB is a bidirectional I/O port. |
| T1CK | I | ST | No | Timer1 external clock input. |
| T2CK | I | ST | Yes | Timer2 external clock input. |
| T3CK | I | ST | Yes | Timer3 external clock input. |
| $\overline{U1CTS}$ | I | ST | Yes | UART1 clear to send. |
| $\overline{U1RTS}$ | O | — | Yes | UART1 ready to send. |
| U1RX | I | ST | Yes | UART1 receive. |
| U1TX | O | — | Yes | UART1 transmit. |
| SCK1 | I/O | ST | Yes | Synchronous serial clock input/output for SPI1. |
| SDI1 | I | ST | Yes | SPI1 data in. |
| SDO1 | O | — | Yes | SPI1 data out. |
| SS1 | I/O | ST | Yes | SPI1 slave synchronization or frame pulse I/O. |
| SCL1 | I/O | ST | No | Synchronous serial clock input/output for I2C1. |
| SDA1 | I/O | ST | No | Synchronous serial data input/output for I2C1. |
| ASCL1 | I/O | ST | No | Alternate synchronous serial clock input/output for I2C1. |
| ASDA1 | I/O | ST | No | Alternate synchronous serial data input/output for I2C1. |
| TMS | I | ST | No | JTAG Test mode select pin. |
| TCK | I | ST | No | JTAG test clock input pin. |
| TDI | I | ST | No | JTAG test data input pin. |
| TDO | O | — | No | JTAG test data output pin. |

Legend: CMOS = CMOS compatible input or output Analog = Analog input P = Power
 ST = Schmitt Trigger input with CMOS levels O = Output I = Input
 PPS = Peripheral Pin Select

dsPIC33FJ12MC201/202

TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

| Pin Name | Pin Type | Buffer Type | PPS | Description |
|----------|----------|-------------|-----|---|
| INDX | I | ST | Yes | Quadrature Encoder Index Pulse input. |
| QEA | I | ST | Yes | Quadrature Encoder Phase A input in QEI mode. |
| QEB | I | ST | Yes | Auxiliary Timer External Clock/Gate input in Timer mode. Quadrature Encoder Phase A input in QEI mode. |
| UPDN | O | CMOS | Yes | Auxiliary Timer External Clock/Gate input in Timer mode. Position Up/Down Counter Direction State. |
| FLTA1 | I | ST | Yes | PWM1 Fault A input. |
| PWM1L1 | O | — | No | PWM1 Low output 1 |
| PWM1H1 | O | — | No | PWM1 High output 1 |
| PWM1L2 | O | — | No | PWM1 Low output 2 |
| PWM1H2 | O | — | No | PWM1 High output 2 |
| PWM1L3 | O | — | No | PWM1 Low output 3 |
| PWM1H3 | O | — | No | PWM1 High output 3 |
| FLTA2 | I | ST | Yes | PWM2 Fault A input. |
| PWM2L1 | O | — | No | PWM2 Low output 1 |
| PWM2H1 | O | — | No | PWM2 High output 1 |
| PGED1 | I/O | ST | No | Data I/O pin for programming/debugging communication channel 1. |
| PGEC1 | I | ST | No | Clock input pin for programming/debugging communication channel 1. |
| PGED2 | I/O | ST | No | Data I/O pin for programming/debugging communication channel 2. |
| PGEC2 | I | ST | No | Clock input pin for programming/debugging communication channel 2. |
| PGED3 | I/O | ST | No | Data I/O pin for programming/debugging communication channel 3. |
| PGEC3 | I | ST | No | Clock input pin for programming/debugging communication channel 3. |
| MCLR | I/P | ST | No | Master Clear (Reset) input. This pin is an active-low Reset to the device. |
| AVDD | P | P | No | Positive supply for analog modules. This pin must be connected at all times. |
| AVSS | P | P | No | Ground reference for analog modules. |
| VDD | P | — | No | Positive supply for peripheral logic and I/O pins. |
| VCAP | P | — | No | CPU logic filter capacitor connection. |
| VSS | P | — | No | Ground reference for logic and I/O pins. |
| VREF+ | I | Analog | No | Analog voltage reference (high) input. |
| VREF- | I | Analog | No | Analog voltage reference (low) input. |

Legend: CMOS = CMOS compatible input or output Analog = Analog input P = Power
 ST = Schmitt Trigger input with CMOS levels O = Output I = Input
 PPS = Peripheral Pin Select

1.1 Referenced Sources

This device data sheet is based on the following individual chapters of the “*dsPIC33F/PIC24H Family Reference Manual*”. These documents should be considered as the general reference for the operation of a particular module or device feature.

Note 1: To access the documents listed below, browse to the documentation section of the dsPIC33FJ12MC202 product page of the Microchip web site (www.microchip.com) or select a family reference manual section from the following list.

In addition to parameters, features, and other documentation, the resulting page provides links to the related family reference manual sections.

- **Section 1. “Introduction”** (DS70197)
- **Section 2. “CPU”** (DS70204)
- **Section 3. “Data Memory”** (DS70202)
- **Section 4. “Program Memory”** (DS70202)
- **Section 5. “Flash Programming”** (DS70191)
- **Section 6. “Interrupts”** (DS70184)
- **Section 7. “Oscillator”** (DS70186)
- **Section 8. “Reset”** (DS70192)
- **Section 9. “Watchdog Timer and Power-Saving Modes”** (DS70196)
- **Section 10. “I/O Ports”** (DS70193)
- **Section 11. “Timers”** (DS70205)
- **Section 12. “Input Capture”** (DS70198)
- **Section 13. “Output Compare”** (DS70209)
- **Section 14. “Motor Control PWM”** (DS70187)
- **Section 15. “Quadrature Encoder Interface (QEI)”** (DS70208)
- **Section 16. “Analog-to-Digital Converter (ADC)”** (DS70183)
- **Section 17. “UART”** (DS70188)
- **Section 18. “Serial Peripheral Interface (SPI)”** (DS70206)
- **Section 19. “Inter-Integrated Circuit™ (I²C™)”** (DS70195)
- **Section 23. “CodeGuard Security”** (DS70199)
- **Section 25. “Device Configuration”** (DS70194)

dsPIC33FJ12MC201/202

NOTES:

2.0 GUIDELINES FOR GETTING STARTED WITH 16-BIT DIGITAL SIGNAL CONTROLLERS

Note: This data sheet summarizes the features of the dsPIC33FJ12MC201/202 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the “*dsPIC33F Family Reference Manual*”, which is available from the Microchip web site (www.microchip.com).

2.1 Basic Connection Requirements

Getting started with the dsPIC33FJ12MC201/202 family of 16-bit Digital Signal Controllers (DSC) requires attention to a minimal set of device pin connections before proceeding with development. The following is a list of pin names, which must always be connected:

- All VDD and VSS pins (see [Section 2.2 “Decoupling Capacitors”](#))
- All AVDD and AVSS pins (regardless if ADC module is not used) (see [Section 2.2 “Decoupling Capacitors”](#))
- VCAP (see [Section 2.3 “CPU Logic Filter Capacitor Connection \(VCAP\)”](#))
- MCLR pin (see [Section 2.4 “Master Clear \(MCLR\) Pin”](#))
- PGECx/PGEDx pins used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes (see [Section 2.5 “ICSP Pins”](#))
- OSC1 and OSC2 pins when external oscillator source is used (see [Section 2.6 “External Oscillator Pins”](#))

Additionally, the following pins may be required:

- VREF+/VREF- pins used when external voltage reference for ADC module is implemented

Note: The AVDD and AVSS pins must be connected independent of the ADC voltage reference source.

2.2 Decoupling Capacitors

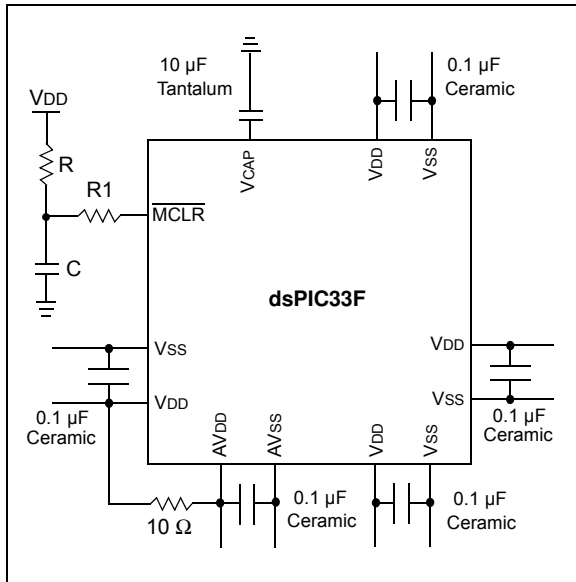
The use of decoupling capacitors on every pair of power supply pins, such as VDD, VSS, AVDD, and AVSS is required.

Consider the following criteria when using decoupling capacitors:

- **Value and type of capacitor:** Recommendation of 0.1 μF (100 nF), 10-20V. This capacitor should be a low-ESR and have resonance frequency in the range of 20 MHz and higher. It is recommended that ceramic capacitors be used.
- **Placement on the printed circuit board:** The decoupling capacitors should be placed as close to the pins as possible. It is recommended to place the capacitors on the same side of the board as the device. If space is constricted, the capacitor can be placed on another layer on the PCB using a via; however, ensure that the trace length from the pin to the capacitor is within one-quarter inch (6 mm) in length.
- **Handling high frequency noise:** If the board is experiencing high frequency noise, upward of tens of MHz, add a second ceramic-type capacitor in parallel to the above described decoupling capacitor. The value of the second capacitor can be in the range of 0.01 μF to 0.001 μF . Place this second capacitor next to the primary decoupling capacitor. In high-speed circuit designs, consider implementing a decade pair of capacitances as close to the power and ground pins as possible. For example, 0.1 μF in parallel with 0.001 μF .
- **Maximizing performance:** On the board layout from the power supply circuit, run the power and return traces to the decoupling capacitors first, and then to the device pins. This ensures that the decoupling capacitors are first in the power chain. Equally important is to keep the trace length between the capacitor and the power pins to a minimum thereby reducing PCB track inductance.

dsPIC33FJ12MC201/202

FIGURE 2-1: RECOMMENDED MINIMUM CONNECTION



2.2.1 TANK CAPACITORS

On boards with power traces running longer than six inches in length, it is suggested to use a tank capacitor for integrated circuits including DSCs to supply a local power source. The value of the tank capacitor should be determined based on the trace resistance that connects the power supply source to the device, and the maximum current drawn by the device in the application. In other words, select the tank capacitor so that it meets the acceptable voltage sag at the device. Typical values range from 4.7 µF to 47 µF.

2.3 CPU Logic Filter Capacitor Connection (VCAP)

A low-ESR (< 5 Ohms) capacitor is required on the VCAP pin, which is used to stabilize the voltage regulator output voltage. The VCAP pin must not be connected to VDD, and must have a capacitor between 4.7 µF and 10 µF, 16V connected to ground. The type can be ceramic or tantalum. Refer to [Section 24.0 “Electrical Characteristics”](#) for additional information.

The placement of this capacitor should be close to the VCAP. It is recommended that the trace length not exceed one-quarter inch (6 mm). Refer to [Section 21.2 “On-Chip Voltage Regulator”](#) for details.

2.4 Master Clear ($\overline{\text{MCLR}}$) Pin

The $\overline{\text{MCLR}}$ pin provides for two specific device functions:

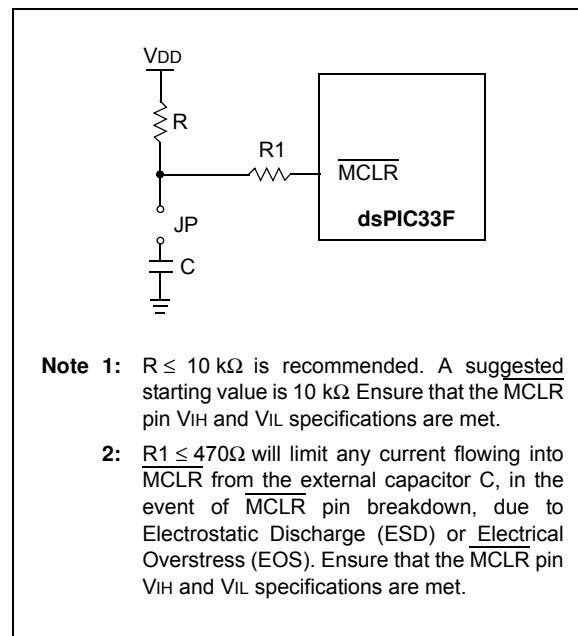
- Device Reset
- Device programming and debugging

During device programming and debugging, the resistance and capacitance that can be added to the pin must be considered. Device programmers and debuggers drive the $\overline{\text{MCLR}}$ pin. Consequently, specific voltage levels (V_{IH} and V_{IL}) and fast signal transitions must not be adversely affected. Therefore, specific values of R and C will need to be adjusted based on the application and PCB requirements.

For example, as shown in [Figure 2-2](#), it is recommended that the capacitor C, be isolated from the $\overline{\text{MCLR}}$ pin during programming and debugging operations.

Place the components shown in [Figure 2-2](#) within one-quarter inch (6 mm) from the $\overline{\text{MCLR}}$ pin.

FIGURE 2-2: EXAMPLE OF $\overline{\text{MCLR}}$ PIN CONNECTIONS



2.5 ICSP Pins

The PGECx and PGEDx pins are used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of Ohms, not to exceed 100 Ohms.

Pull-up resistors, series diodes, and capacitors on the PGECx and PGEDx pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternately, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits and pin input voltage high (V_{IH}) and input low (V_{IL}) requirements.

Ensure that the “Communication Channel Select” (i.e., PGECx/PGEDx pins) programmed into the device matches the physical connections for the ICSP to MPLAB® ICD 2, MPLAB ICD 3, or MPLAB REAL ICE™.

For more information on ICD 2, ICD 3, and REAL ICE connection requirements, refer to the following documents that are available on the Microchip web site.

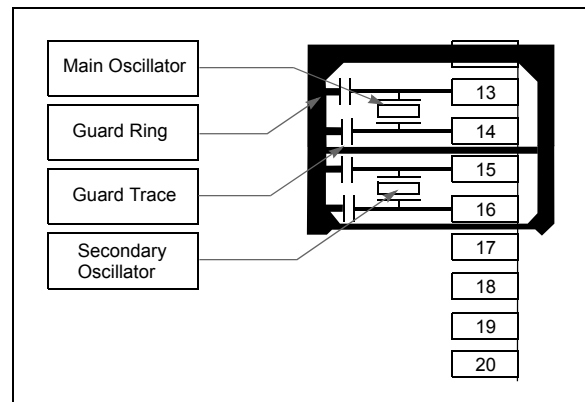
- “MPLAB® ICD 2 In-Circuit Debugger User’s Guide” DS51331
- “Using MPLAB® ICD 2” (poster) DS51265
- “MPLAB® ICD 2 Design Advisory” DS51566
- “Using MPLAB® ICD 3” (poster) DS51765
- “MPLAB® ICD 3 Design Advisory” DS51764
- “MPLAB® REAL ICE™ In-Circuit Debugger User’s Guide” DS51616
- “Using MPLAB® REAL ICE™” (poster) DS51749

2.6 External Oscillator Pins

Many DSCs have options for at least two oscillators: a high-frequency primary oscillator and a low-frequency secondary oscillator (refer to [Section 8.0 “Oscillator Configuration”](#) for details).

The oscillator circuit should be placed on the same side of the board as the device. Also, place the oscillator circuit close to the respective oscillator pins, not exceeding one-half inch (12 mm) distance between them. The load capacitors should be placed next to the oscillator itself, on the same side of the board. Use a grounded copper pour around the oscillator circuit to isolate them from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed. A suggested layout is shown in [Figure 2-3](#).

FIGURE 2-3: SUGGESTED PLACEMENT OF THE OSCILLATOR CIRCUIT



2.7 Oscillator Value Conditions on Device Start-up

If the PLL of the target device is enabled and configured for the device start-up oscillator, the maximum oscillator source frequency must be limited to $4 \text{ MHz} < F_{\text{IN}} < 8 \text{ MHz}$ to comply with device PLL start-up conditions. This means that if the external oscillator frequency is outside this range, the application must start-up in the FRC mode first. The default PLL settings after a POR with an oscillator frequency outside this range will violate the device operating speed.

Once the device powers up, the application firmware can initialize the PLL SFRs, CLKDIV, and PLLDBF to a suitable value, and then perform a clock switch to the Oscillator + PLL clock source. Note that clock switching must be enabled in the device Configuration word.

2.8 Configuration of Analog and Digital Pins During ICSP Operations

If MPLAB ICD 2, MPLAB ICD 3, or MPLAB REAL ICE in-circuit emulator is selected as a debugger, it automatically initializes all of the A/D input pins (ANx) as “digital” pins, by setting all bits in the AD1PCFGL register.

The bits in the register that correspond to the A/D pins that are initialized by MPLAB ICD 2, MPLAB ICD 3, or MPLAB REAL ICE in-circuit emulator, must not be cleared by the user application firmware; otherwise, communication errors will result between the debugger and the device.

If your application needs to use certain A/D pins as analog input pins during the debug session, the user application must clear the corresponding bits in the AD1PCFGL register during initialization of the ADC module.

When MPLAB ICD 2, MPLAB ICD 3, or MPLAB REAL ICE in-circuit emulator is used as a programmer, the user application firmware must correctly configure the AD1PCFGL register. Automatic initialization of this register is only done during debugger operation. Failure to correctly configure the register(s) will result in all A/D pins being recognized as analog input pins, resulting in the port value being read as a logic ‘0’, which may affect user application functionality.

2.9 Unused I/Os

Unused I/O pins should be configured as outputs and driven to a logic-low state.

Alternately, connect a 1k to 10k resistor between V_{SS} and unused pins and drive the output to logic low.

3.0 CPU

Note 1: This data sheet summarizes the features of the dsPIC33FJ12MC201/202 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 2. “CPU”** (DS70204) of the “*dsPIC33F/PIC24H Family Reference Manual*”, which is available from the Microchip website (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

The dsPIC33FJ12MC201/202 CPU module has a 16-bit (data) modified Harvard architecture with an enhanced instruction set, including significant support for DSP. The CPU has a 24-bit instruction word with a variable length opcode field. The Program Counter (PC) is 23 bits wide and addresses up to 4M x 24 bits of user program memory space. The actual amount of program memory implemented varies by device. A single-cycle instruction prefetch mechanism is used to help maintain throughput and provides predictable execution. All instructions execute in a single cycle, with the exception of instructions that change the program flow, the double-word move (MOV.D) instruction and the table instructions. Overhead-free program loop constructs are supported using the DO and REPEAT instructions, both of which are interruptible at any point.

The dsPIC33FJ12MC201/202 devices have sixteen, 16-bit working registers in the programmer's model. Each of the working registers can serve as a data, address, or address offset register. The 16th working register (W15) operates as a software Stack Pointer (SP) for interrupts and calls.

There are two classes of instruction in the dsPIC33FJ12MC201/202 devices: MCU and DSP. These two instruction classes are seamlessly integrated into a single CPU. The instruction set includes many addressing modes and is designed for optimum C compiler efficiency. For most instructions, dsPIC33FJ12MC201/202 devices are capable of executing a data (or program data) memory read, a working register (data) read, a data memory write, and a program (instruction) memory read per instruction cycle. As a result, three parameter instructions can be supported, allowing $A + B = C$ operations to be executed in a single cycle.

A block diagram of the CPU is shown in [Figure 3-1](#), and the programmer's model for the dsPIC33FJ12MC201/202 is shown in [Figure 3-2](#).

3.1 Data Addressing Overview

The data space can be addressed as 32K words or 64 Kbytes and is split into two blocks, referred to as X and Y data memory. Each memory block has its own independent Address Generation Unit (AGU). The MCU class of instructions operates solely through the X memory AGU, which accesses the entire memory map as one linear data space. Certain DSP instructions operate through the X and Y AGUs to support dual operand reads, which splits the data address space into two parts. The X and Y data space boundary is device-specific.

Overhead-free circular buffers (Modulo Addressing mode) are supported in both X and Y address spaces. The Modulo Addressing removes the software boundary checking overhead for DSP algorithms. Furthermore, the X AGU circular addressing can be used with any of the MCU class of instructions. The X AGU also supports Bit-Reversed Addressing to greatly simplify input or output data reordering for radix-2 FFT algorithms.

The upper 32 Kbytes of the data space memory map can optionally be mapped into program space at any 16K program word boundary defined by the 8-bit Program Space Visibility Page (PSVPAG) register. The program-to-data-space mapping feature lets any instruction access program space as if it were data space.

3.2 DSP Engine Overview

The DSP engine features a high-speed 17-bit by 17-bit multiplier, a 40-bit ALU, two 40-bit saturating accumulators, and a 40-bit bidirectional barrel shifter. The barrel shifter is capable of shifting a 40-bit value up to 16 bits right or left, in a single cycle. The DSP instructions operate seamlessly with all other instructions and have been designed for optimal real-time performance. The MAC instruction and other associated instructions can concurrently fetch two data operands from memory, while multiplying two W registers and accumulating and optionally saturating the result in the same cycle. This instruction functionality requires that the RAM data space be split for these instructions and linear for all others. Data space partitioning is achieved in a transparent and flexible manner through dedicating certain working registers to each address space.

3.3 Special MCU Features

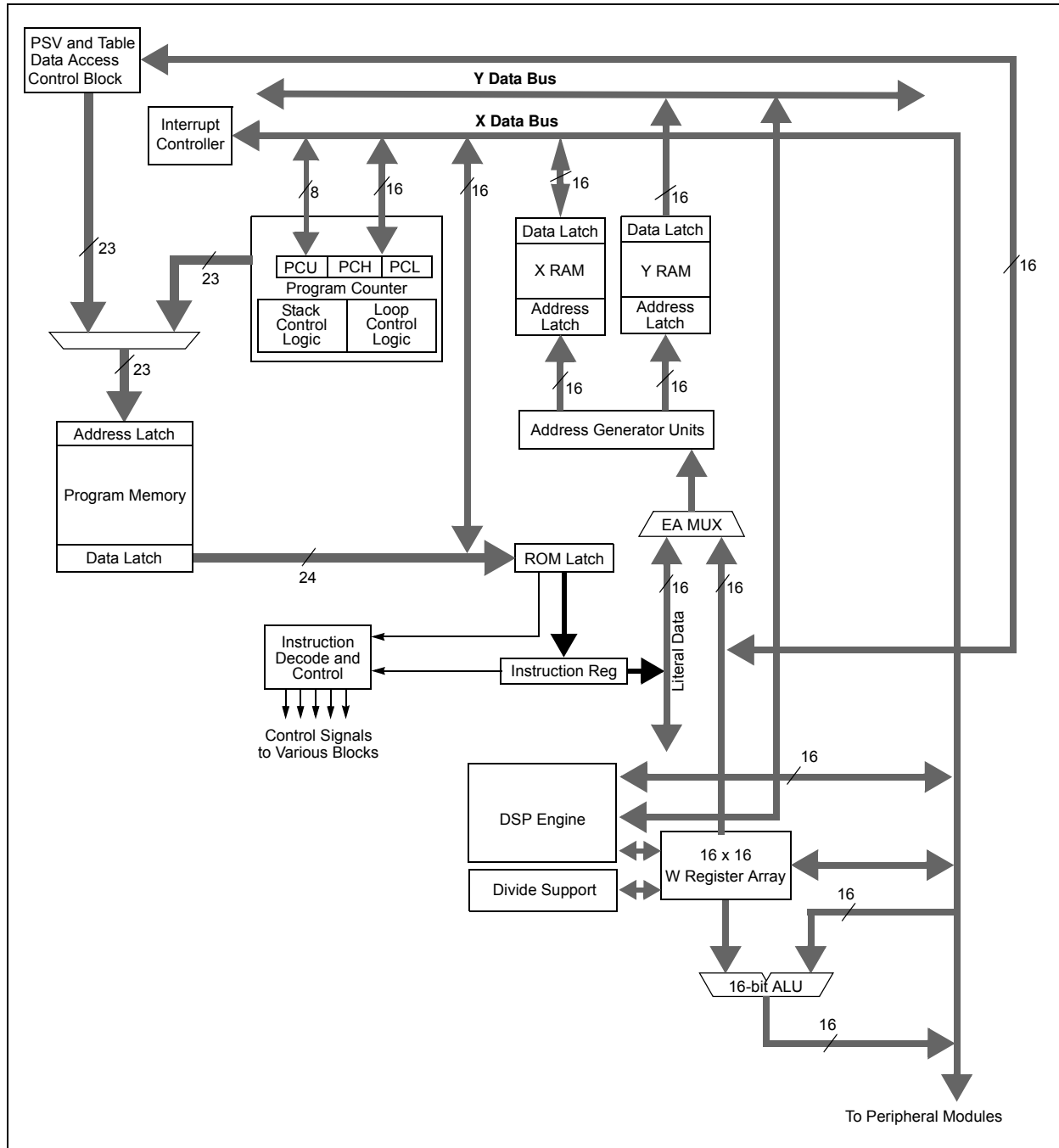
The dsPIC33FJ12MC201/202 features a 17-bit by 17-bit single-cycle multiplier that is shared by both the MCU ALU and DSP engine. The multiplier can perform signed, unsigned and mixed-sign multiplication. Using a 17-bit by 17-bit multiplier for 16-bit by 16-bit multiplication not only allows you to perform mixed-sign multiplication, it also achieves accurate results for special operations, such as $(-1.0) \times (-1.0)$.

dsPIC33FJ12MC201/202

The dsPIC33FJ12MC201/202 supports 16/16 and 32/16 divide operations, both fractional and integer. All divide instructions are iterative operations. They must be executed within a REPEAT loop, resulting in a total execution time of 19 instruction cycles. The divide operation can be interrupted during any of those 19 cycles without loss of data.

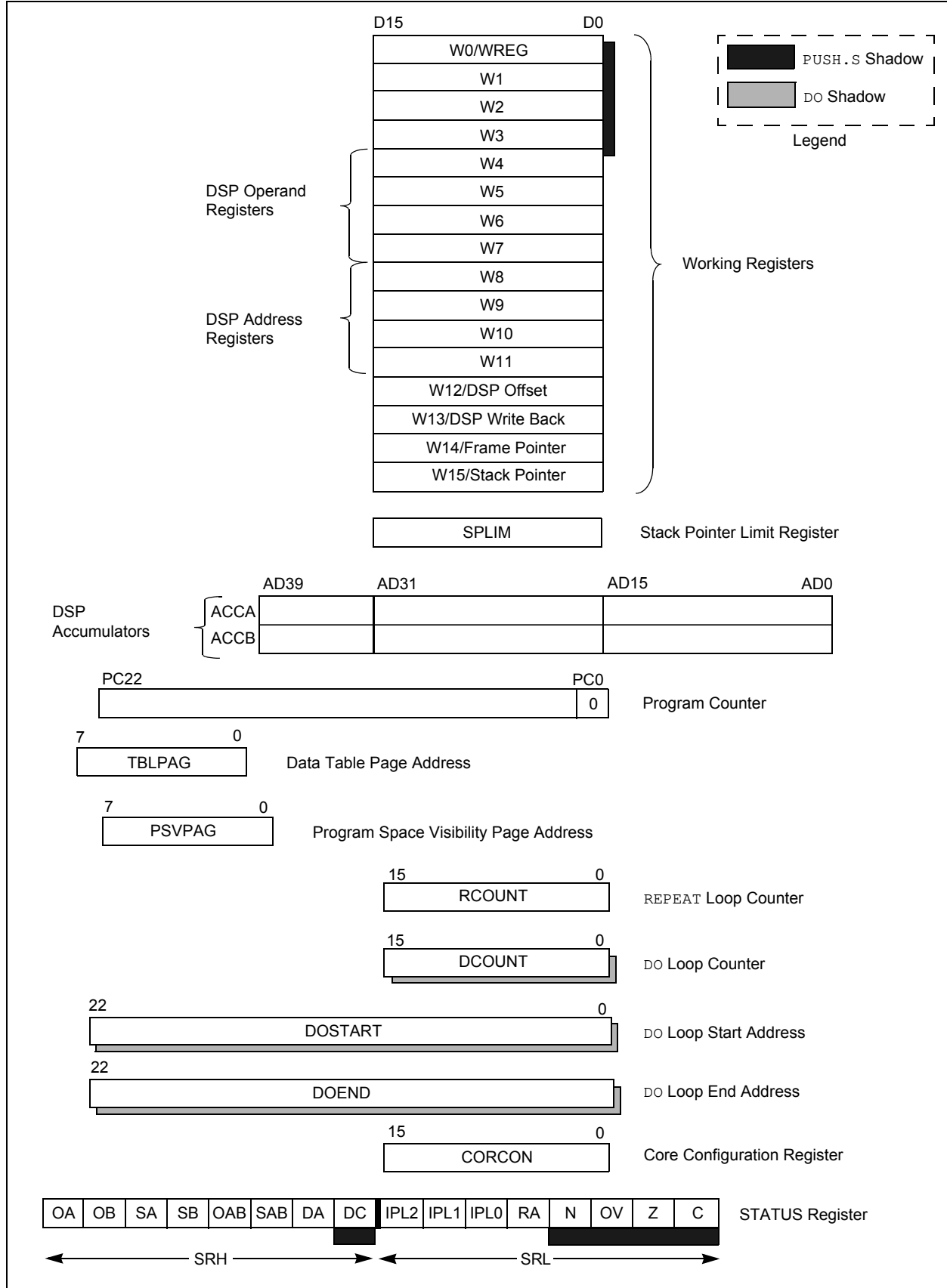
A 40-bit barrel shifter is used to perform up to a 16-bit left or right shift in a single cycle. The barrel shifter can be used by both MCU and DSP instructions.

FIGURE 3-1: dsPIC33FJ12MC201/202 CPU CORE BLOCK DIAGRAM



dsPIC33FJ12MC201/202

FIGURE 3-2: dsPIC33FJ12MC201/202 PROGRAMMER'S MODEL



dsPIC33FJ12MC201/202

3.4 CPU Control Registers

REGISTER 3-1: SR: CPU STATUS REGISTER

| | | | | | | | |
|--------|-----|-------------------|-------------------|-----|-------|-------|-------|
| R-0 | R-0 | R/C-0 | R/C-0 | R-0 | R/C-0 | R-0 | R/W-0 |
| OA | OB | SA ⁽¹⁾ | SB ⁽¹⁾ | OAB | SAB | DA | DC |
| bit 15 | | | | | | bit 8 | |

| | | | | | | | |
|-------------------------|----------------------|----------------------|-----|-------|-------|-------|-------|
| R/W-0 ⁽²⁾ | R/W-0 ⁽³⁾ | R/W-0 ⁽³⁾ | R-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
| IPL<2:0> ⁽²⁾ | | | RA | N | OV | Z | C |
| bit 7 | | | | | | bit 0 | |

Legend:

| | | |
|--------------------|----------------------|------------------------------------|
| C = Clear only bit | R = Readable bit | U = Unimplemented bit, read as '0' |
| S = Set only bit | W = Writable bit | -n = Value at POR |
| '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

- bit 15 **OA:** Accumulator A Overflow Status bit
 1 = Accumulator A overflowed
 0 = Accumulator A has not overflowed
- bit 14 **OB:** Accumulator B Overflow Status bit
 1 = Accumulator B overflowed
 0 = Accumulator B has not overflowed
- bit 13 **SA:** Accumulator A Saturation 'Sticky' Status bit⁽¹⁾
 1 = Accumulator A is saturated or has been saturated at some time
 0 = Accumulator A is not saturated
- bit 12 **SB:** Accumulator B Saturation 'Sticky' Status bit⁽¹⁾
 1 = Accumulator B is saturated or has been saturated at some time
 0 = Accumulator B is not saturated
- bit 11 **OAB:** OA || OB Combined Accumulator Overflow Status bit
 1 = Accumulators A or B have overflowed
 0 = Neither Accumulators A or B have overflowed
- bit 10 **SAB:** SA || SB Combined Accumulator 'Sticky' Status bit
 1 = Accumulators A or B are saturated or have been saturated at some time in the past
 0 = Neither Accumulator A or B are saturated
 This bit may be read or cleared (not set). *Clearing this bit will clear SA and SB.*
- bit 9 **DA:** DO Loop Active bit
 1 = DO loop in progress
 0 = DO loop not in progress
- bit 8 **DC:** MCU ALU Half Carry/Borrow bit
 1 = A carry-out from the 4th low-order bit (for byte-sized data) or 8th low-order bit (for word-sized data) of the result occurred
 0 = No carry-out from the 4th low-order bit (for byte-sized data) or 8th low-order bit (for word-sized data) of the result occurred

- Note 1:** This bit can be read or cleared (not set).
- Note 2:** The IPL<2:0> bits are concatenated with the IPL<3> bit (CORCON<3>) to form the CPU Interrupt Priority Level. The value in parentheses indicates the IPL if IPL<3> = 1. User interrupts are disabled when IPL<3> = 1.
- Note 3:** The IPL<2:0> Status bits are read-only when NSTDIS = 1 (INTCON1<15>).

REGISTER 3-1: SR: CPU STATUS REGISTER (CONTINUED)

| | |
|---------|---|
| bit 7-5 | IPL<2:0> : CPU Interrupt Priority Level Status bits ⁽²⁾ 111 = CPU Interrupt Priority Level is 7 (15), user interrupts disabled 110 = CPU Interrupt Priority Level is 6 (14) 101 = CPU Interrupt Priority Level is 5 (13) 100 = CPU Interrupt Priority Level is 4 (12) 011 = CPU Interrupt Priority Level is 3 (11) 010 = CPU Interrupt Priority Level is 2 (10) 001 = CPU Interrupt Priority Level is 1 (9) 000 = CPU Interrupt Priority Level is 0 (8) |
| bit 4 | RA : REPEAT Loop Active bit 1 = REPEAT loop in progress 0 = REPEAT loop not in progress |
| bit 3 | N : MCU ALU Negative bit 1 = Result was negative 0 = Result was non-negative (zero or positive) |
| bit 2 | OV : MCU ALU Overflow bit This bit is used for signed arithmetic (2's complement). It indicates an overflow of a magnitude that causes the sign bit to change state. 1 = Overflow occurred for signed arithmetic (in this arithmetic operation) 0 = No overflow occurred |
| bit 1 | Z : MCU ALU Zero bit 1 = An operation that affects the Z bit has set it at some time in the past 0 = The most recent operation that affects the Z bit has cleared it (i.e., a non-zero result) |
| bit 0 | C : MCU ALU Carry/Borrow bit 1 = A carry-out from the Most Significant bit of the result occurred 0 = No carry-out from the Most Significant bit of the result occurred |

- Note 1:** This bit can be read or cleared (not set).
- 2:** The IPL<2:0> bits are concatenated with the IPL<3> bit (CORCON<3>) to form the CPU Interrupt Priority Level. The value in parentheses indicates the IPL if IPL<3> = 1. User interrupts are disabled when IPL<3> = 1.
- 3:** The IPL<2:0> Status bits are read-only when NSTDIS = 1 (INTCON1<15>).

dsPIC33FJ12MC201/202

REGISTER 3-2: CORCON: CORE CONTROL REGISTER

| | | | | | | | | |
|--------|-----|-----|-------|--------------------|---------|-----|-----|-------|
| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R-0 | R-0 | R-0 | |
| — | — | — | US | EDT ⁽¹⁾ | DL<2:0> | | | |
| bit 15 | | | | | | | | bit 8 |

| | | | | | | | |
|-------|-------|-------|--------|---------------------|-------|-------|-------|
| R/W-0 | R/W-0 | R/W-1 | R/W-0 | R/C-0 | R/W-0 | R/W-0 | R/W-0 |
| SATA | SATB | SATDW | ACCSAT | IPL3 ⁽²⁾ | PSV | RND | IF |
| bit 7 | | | | | | | bit 0 |

| | | | |
|---------------------|----------------------|------------------------------------|------------------|
| Legend: | C = Clear only bit | | |
| R = Readable bit | W = Writable bit | -n = Value at POR | '1' = Bit is set |
| 0' = Bit is cleared | 'x' = Bit is unknown | U = Unimplemented bit, read as '0' | |

- bit 15-13 **Unimplemented:** Read as '0'
- bit 12 **US:** DSP Multiply Unsigned/Signed Control bit
 - 1 = DSP engine multiplies are unsigned
 - 0 = DSP engine multiplies are signed
- bit 11 **EDT:** Early DO Loop Termination Control bit⁽¹⁾
 - 1 = Terminate executing DO loop at end of current loop iteration
 - 0 = No effect
- bit 10-8 **DL<2:0>:** DO Loop Nesting Level Status bits
 - 111 = 7 DO loops active
 -
 -
 -
 - 001 = 1 DO loop active
 - 000 = 0 DO loops active
- bit 7 **SATA:** ACCA Saturation Enable bit
 - 1 = Accumulator A saturation enabled
 - 0 = Accumulator A saturation disabled
- bit 6 **SATB:** ACCB Saturation Enable bit
 - 1 = Accumulator B saturation enabled
 - 0 = Accumulator B saturation disabled
- bit 5 **SATDW:** Data Space Write from DSP Engine Saturation Enable bit
 - 1 = Data space write saturation enabled
 - 0 = Data space write saturation disabled
- bit 4 **ACCSAT:** Accumulator Saturation Mode Select bit
 - 1 = 9.31 saturation (super saturation)
 - 0 = 1.31 saturation (normal saturation)
- bit 3 **IPL3:** CPU Interrupt Priority Level Status bit 3⁽²⁾
 - 1 = CPU interrupt priority level is greater than 7
 - 0 = CPU interrupt priority level is 7 or less
- bit 2 **PSV:** Program Space Visibility in Data Space Enable bit
 - 1 = Program space visible in data space
 - 0 = Program space not visible in data space
- bit 1 **RND:** Rounding Mode Select bit
 - 1 = Biased (conventional) rounding enabled
 - 0 = Unbiased (convergent) rounding enabled
- bit 0 **IF:** Integer or Fractional Multiplier Mode Select bit
 - 1 = Integer mode enabled for DSP multiply ops
 - 0 = Fractional mode enabled for DSP multiply ops

- Note 1:** This bit will always read as '0'.
- Note 2:** The IPL3 bit is concatenated with the IPL<2:0> bits (SR<7:5>) to form the CPU interrupt priority level.

3.5 Arithmetic Logic Unit (ALU)

The dsPIC33FJ12MC201/202 ALU is 16 bits wide and is capable of addition, subtraction, bit shifts, and logic operations. Unless otherwise mentioned, arithmetic operations are 2's complement in nature. Depending on the operation, the ALU can affect the values of the Carry (C), Zero (Z), Negative (N), Overflow (OV), and Digit Carry (DC) Status bits in the SR register. The C and DC Status bits operate as Borrow and Digit Borrow bits, respectively, for subtraction operations.

The ALU can perform 8-bit or 16-bit operations, depending on the mode of the instruction that is used. Data for the ALU operation can come from the W register array or data memory, depending on the addressing mode of the instruction. Likewise, output data from the ALU can be written to the W register array or a data memory location.

Refer to the "16-bit MCU and DSC Programmer's Reference Manual" (DS70157) for information on the SR bits affected by each instruction.

The dsPIC33FJ12MC201/202 CPU incorporates hardware support for both multiplication and division. This includes a dedicated hardware multiplier and support hardware for 16-bit-divisor division.

3.5.1 MULTIPLIER

Using the high-speed 17-bit x 17-bit multiplier of the DSP engine, the ALU supports unsigned, signed or mixed-sign operation in several MCU multiplication modes:

- 16-bit x 16-bit signed
- 16-bit x 16-bit unsigned
- 16-bit signed x 5-bit (literal) unsigned
- 16-bit unsigned x 16-bit unsigned
- 16-bit unsigned x 5-bit (literal) unsigned
- 16-bit unsigned x 16-bit signed
- 8-bit unsigned x 8-bit unsigned

3.5.2 DIVIDER

The divide block supports 32-bit/16-bit and 16-bit/16-bit signed and unsigned integer divide operations with the following data sizes:

1. 32-bit signed/16-bit signed divide
2. 32-bit unsigned/16-bit unsigned divide
3. 16-bit signed/16-bit signed divide
4. 16-bit unsigned/16-bit unsigned divide

The quotient for all divide instructions ends up in W0 and the remainder in W1. 16-bit signed and unsigned DIV instructions can specify any W register for both the 16-bit divisor (Wn) and any W register (aligned) pair (W(m + 1):Wm) for the 32-bit dividend. The divide algorithm takes one cycle per bit of divisor, so both 32-bit/16-bit and 16-bit/16-bit instructions take the same number of cycles to execute.

3.6 DSP Engine

The DSP engine consists of a high-speed 17-bit x 17-bit multiplier, a barrel shifter and a 40-bit adder/subtractor (with two target accumulators, round and saturation logic).

The dsPIC33FJ12MC201/202 is a single-cycle instruction flow architecture; therefore, concurrent operation of the DSP engine with MCU instruction flow is not possible. However, some MCU ALU and DSP engine resources can be used concurrently by the same instruction (e.g., ED, EDAC).

The DSP engine can also perform inherent accumulator-to-accumulator operations that require no additional data. These instructions are ADD, SUB, and NEG.

The DSP engine has options selected through bits in the CPU Core Control register (CORCON), as listed below:

- Fractional or integer DSP multiply (IF)
- Signed or unsigned DSP multiply (US)
- Conventional or convergent rounding (RND)
- Automatic saturation on/off for ACCA (SATA)
- Automatic saturation on/off for ACCB (SATB)
- Automatic saturation on/off for writes to data memory (SATDW)
- Accumulator Saturation mode selection (ACC-SAT)

A block diagram of the DSP engine is shown in [Figure 3-3](#).

TABLE 3-1: DSP INSTRUCTIONS SUMMARY

| Instruction | Algebraic Operation | ACC Write Back |
|-------------|---------------------|----------------|
| CLR | $A = 0$ | Yes |
| ED | $A = (x - y)^2$ | No |
| EDAC | $A = A + (x - y)^2$ | No |
| MAC | $A = A + (x * y)$ | Yes |
| MAC | $A = A + x^2$ | No |
| MOVSAC | No change in A | Yes |
| MPY | $A = x * y$ | No |
| MPY | $A = x^2$ | No |
| MPY.N | $A = -x * y$ | No |
| MSC | $A = A - x * y$ | Yes |